# Silicon PIN Photodiode PD526AC-U



#### **Features**

Fast response times

High photo sensitivity

Small junction capacitance

Pb free

The product itself will remain within RoHS compliant version

Compliancewith EU REACH



#### **Application**

High speed photo detector

Camera

Optoelectronic switch

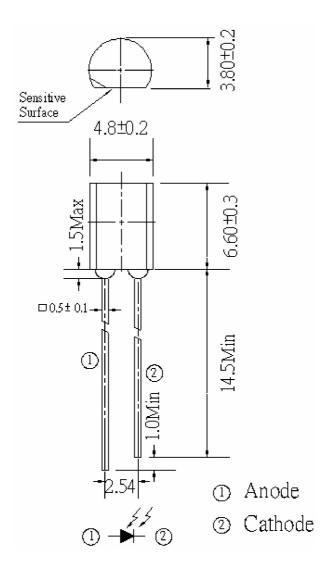
VCRs, Video camera

#### **Description**

PD526AU-C is a high speed and sensitive PIN photodiode in a flat side view plastic package. Due to its water clear epoxy the device is sensitive to visible and infrared radiation.



#### PACKAGE DIMENSIONS



#### NOTES:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm(.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.



### ABSOLUTE MAXIMUM RATINGS AT TA =25°C

Parameter	Symbol	Rating	Units
Reverse Voltage	$V_R$	32	V
Power Dissipation	Pd	150	mW
Lead Soldering Temperature	Tsol	260	$^{\circ}\!\mathbb{C}$
Operating Temperature	Topr	<b>-</b> 40 ∼ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	<b>-</b> 40 ∼ +85	$^{\circ}\!\mathbb{C}$

**Notes:** \*1 Soldering time≦5 seconds



### **ELECTRICAL OPTICAL CHARACTERISTICS AT TA=25°C**

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Rang of Spectral Bandwidth	λ 0.5		400		1100	nm
Wavelength of Peak Sensitivity	λp			940		nm
Open-Circuit Voltage	V <sub>OC</sub>	Ee=5m W/cm <sup>2</sup> $\lambda$ p=940nm	-	0.35	1	V
Short- Circuit Current	$I_{SC}$	Ee=1m W/cm <sup>2</sup> $\lambda$ p=940nm		18		
Reverse Light Current	$I_{\mathrm{L}}$	Ee=1m W/cm <sup>2</sup> $\lambda$ p=940nm $V_R$ =5V	10.2	18		$\mu$ A
Dark Current	Id	Ee=0m W/cm <sup>2</sup> V <sub>R</sub> =10V		5	30	nA
Reverse Breakdown	$BV_R$	Ee=0m W/cm <sup>2</sup> $I_R$ =100 $\mu$ A	32	170		V
Total Capacitance	Ct	$Ee=0m W/cm^2$ $V_R=3V$ $f=1MHZ$		25		pF
Rise/Fall Time	$t_{ m r}/t_{ m f}$	$V_R=10V$ $R_L=1K\Omega$		50/50		nS



### **Typical Electro-Optical Characteristics Curves**

Fig.1 Power Dissipation vs.

**Ambient Temperature** 

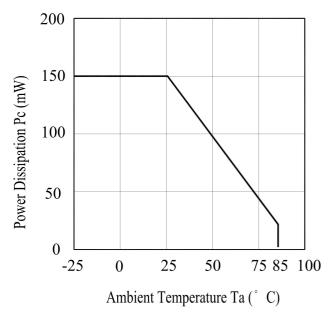


Fig.2 Spectral Sensitivity

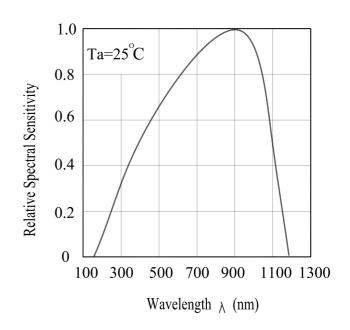


Fig.3 Dark Current vs.
Ambient Temperature

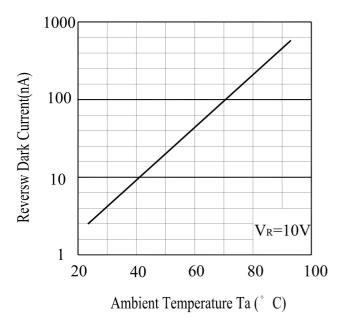
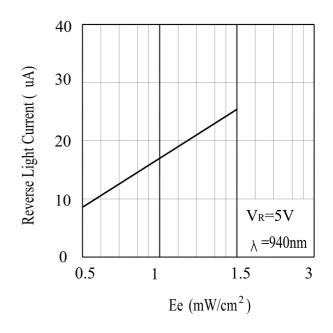


Fig. 4 Reverse Light Current vs.

Ee





### **Typical Electro-Optical Characteristics Curves**

Fig.5 Terminal Capacitance vs. Reverse Voltage

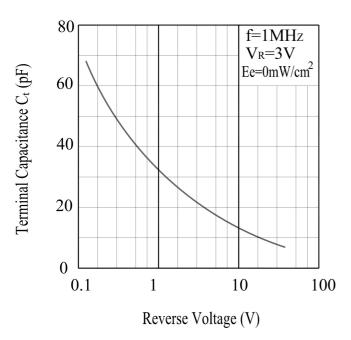
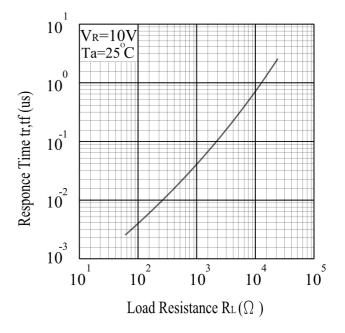


Fig.6 Response Time vs.

Load Resistance



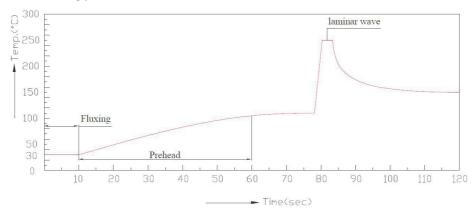


#### **Soldering**

- 1. Careful attention should be paid during soldering. When soldering, leave more than 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- 2. Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
	3mm Min.(From solder		3mm Min. (From solder joint	
Distance	joint to epoxy bulb)	Distance	to epoxy bulb)	

3. Recommended soldering profile



- 4. Avoiding applying any stress to the lead frame while the Photodiode are at high temperature particularly when soldering.
- 5. Dip and hand soldering should not be done more than one time
- 6. After soldering the Photodiode, the epoxy bulb should be protected from mechanical shock or vibration until the Photodiode return to room temperature.
- 7.A rapid-rate process is not recommended for cooling the Photodiode down from the peak temperature.
- 8. Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the Photodiode.
- 9. Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.



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